



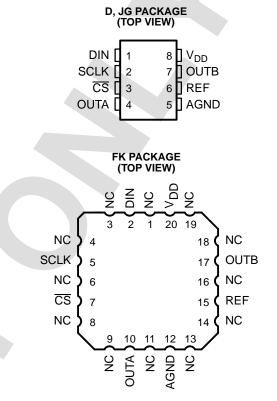
2.7-V TO 5.5-V LOW-POWER DUAL 12-BIT DIGITAL-TO-ANALOG CONVERTER WITH INTERNAL REFERENCE AND POWER DOWN

FEATURES

- Dual 12-Bit Voltage Output DAC
- Programmable Internal Reference
- Programmable Settling Time:
 - 1 µs in Fast Mode,
 - 3.5 µs in Slow Mode
- Compatible With TMS320 and SPI™ Serial Ports
- Differential Nonlinearity <0.5 LSB Typ
- Monotonic Over Temperature

APPLICATIONS

- Digital Servo Control Loops
- Digital Offset and Gain Adjustment
- Industrial Process Control
- Machine and Motion Control Devices
- Mass Storage Devices



DESCRIPTION

The TLV5638 is a dual 12-bit voltage output DAC with a flexible 3-wire serial interface. The serial interface allows glueless interface to TMS320, SPI™, QSPI™, and Microwire™ serial ports. It is programmed with a 16-bit serial string containing 4 control and 12 data bits.

The resistor string output voltage is buffered by a x2 gain rail-to-rail output buffer. The buffer features a Class AB output stage to improve stability and reduce settling time. The programmable settling time of the DAC allows the designer to optimize speed vs power dissipation. With its on-chip programmable precision voltage reference, the TLV5638 simplifies overall system design.

Because of its ability to source up to 1 mA, the reference can also be used as a system reference. Implemented with a CMOS process, the device is designed for single supply operation from 2.7 V to 5.5 V. It is available in an 8-pin SOIC package to reduce board space in standard commercial, industrial, and automotive temperature ranges. It is also available in JG and FK packages in the military temperature range.



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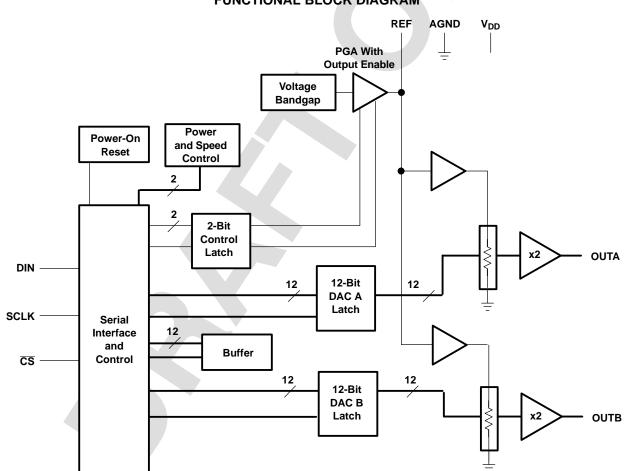


This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

		PACKAGE							
T _A	SOIC (D)	CERAMIC DIP (JG)	20 PAD LCCC (FK)						
0°C to 70°C	TLV5638CD	-	_						
40°C to 85°C	TLV5638ID	—	-						
40°C to 125°C	TLV5638QD TLV5638QDR	_	-						
55°C to 125°C	—	TLV5638MJG	TLV5638MFK						

AVAILABLE OPTIONS



FUNCTIONAL BLOCK DIAGRAM



Terminal Functions

TERM	MINAL		DESCRIPTION
NAME	NO.	I/O/P	DESCRIPTION
AGND	5	Р	Ground
CS	3	1	Chip select. Digital input active low, used to enable/disable inputs
DIN	1	I	Digital serial data input
OUT A	4	0	DAC A analog voltage output
OUT B	7	0	DAC B analog voltage output
REF	6	I/O	Analog reference voltage input/output
SCLK	2	I	Digital serial clock input
V _{DD}	8	Р	Positive power supply

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

			UNIT
Supply voltage (V _{DD} to AGND)			7 V
Reference input voltage range	-0.3 V to V _{DD} + 0.3 V		
Digital input voltage range	-0.3 V to V _{DD} + 0.3 V		
Operating free-air temperature range, T _A	TLV5638C		0°C to 70°C
	TLV5638I		-40°C to 85°C
	TLV5638Q		-40°C to 125°C
	TLV5638M		-55°C to 125°C
Storage temperature range, T _{stg}		-65°C to 150°C	
Lead temperature 1,6 mm (1/16 inch) from c	ase for 10 seconds		260°C

(1) Stresses beyond those listed under, absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under, recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

DISSIPATION RATING TABLE

PACKAGE	T _A ≤ 25°C POWER RATING	DERATING FACTOR ABOVE $T_A = 25^{\circ}C^{(1)}$	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING	T _A = 125°C POWER RATING
D	635 mW	5.08 mW/°C	407 mW	330 mW	127 mW
FK	1375 mW	11.00 mW/°C	880 mW	715 mW	275 mW
JG	1050 mW	8.40 mW/°C	672 mW	546 mW	210 mW

(1) This is the inverse of the traditional Junction-to-Ambient thermal Resistance ($R\theta_{JA}$). Thermal Resistances are not production tested and are for informational purposes only.



RECOMMENDED OPERATING CONDITIONS

			MIN	NOM	MAX	UNIT
	$V_{DD} = 5 V$		4.5	5	5.5	V
Supply voltage, V _{DD}	$V_{DD} = 3 V$		2.7	3	3.3	V
Power on reset, POR			0.55 ⁽¹⁾		2 ⁽¹⁾	V
High lovel digital input valtage V	V _{DD} = 2.7 V		2			V
High-level digital input voltage, V _{IH}	$V_{DD} = 5.5 V$		2.4			
	$V_{DD} = 2.7 V$				0.6	V
Low-level digital input voltage, V _{IL}	V _{DD} = 5.5 V	TLV5638C and TLV5638I			1	V
	$v_{DD} = 5.5 V$	TLV5638Q and TLV5638M			0.8	v
Reference voltage, V _{ref} to REF terminal	$V_{DD} = 5 V^{(2)}$		AGND	2.048	V _{DD} -1.5	V
Reference voltage, V _{ref} to REF terminal	$V_{DD} = 3 V^{(2)}$		AGND	1.024	V _{DD} -1.5	V
Load resistance, R _L			2			kΩ
Load capacitance, C _L					100	pF
Clock frequency, f _{CLK}					20	MHz
	TLV5638C		0		70	
Operating free air temperature T	TLV5638I		40		85	°C
Operating free-air temperature, T _A	TLV5638Q		40		125	C
	TLV5638M		55		125	

This parameter is not tested for Q and M suffix devices.
Due to the x2 output buffer, a reference input voltage ≥ (V_{DD}-0.4 V)/2 causes clipping of the transfer function. The output buffer of the internal reference must be disabled, if an external reference is used.

ELECTRICAL CHARACTERISTICS

over recommended operating conditions, V_{ref} = 2.048 V, V_{ref} = 1.024 V (unless otherwise noted)

POWE	R SUPPLY								
	PARAMETER	TEST CO	TL' TL		UNIT				
			MIN	TYP	MAX				
			V _{DD} = 5 V,	Fast		4.3	7	~^^	
		Int. ref.	Slow		2.2	3.6	mA		
			$V_{DD} = 3 V,$	Fast		3.8	6.3	mA	
	Bower oupply ourrent	No load,	Int. ref.	Slow		1.8	3.0		
DD	Power supply current	All inputs = AGND or V_{DD} , DAC latch = 0x800	V _{DD} = 5 V, Ext. ref.	Fast		3.9	6.3	mA	
				Slow		1.8	3.0		
			V _{DD} = 3 V,	Fast		3.5	5.7		
			Ext. ref.	Slow		1.5	2.6	mA	
	Power-down supply current					0.01	10	μA	
DODD	Bower supply rejection ratio	Zero scale, ⁽¹⁾		65					
PSRR	Power supply rejection ratio	Full scale, ⁽²⁾				65		dB	

(1) Power supply rejection ratio at zero scale is measured by varying V_{DD} and is given by: PSRR = 20 log [(E_{ZS}(V_{DD}max) -E_{ZS}(V_{DD}min))/V_{DD}max]

Power supply rejection ratio at full scale is measured by varying V_{DD} and is given by: PSRR = 20 log [($E_G(V_{DD}max) - E_G(V_{DD}min)$)/ $V_{DD}max$] (2)

ELECTRICAL CHARACTERISTICS (CONTINUED)

over recommended operating conditions, $V_{ref} = 2.048$ V, $V_{ref} = 1.024$ V (unless otherwise noted)

STATIC DAC	SPECIFICATIONS						
	PARAMETER	TEST CONDITION	MIN	TYP	MAX	UNIT	
	Resolution		12			bits	
INL	Integral nonlinearity, end point ad-	See ⁽¹⁾		±1.7	±4	LSB	
IINL	justed		Q and M suffixes		±1.7	±6	LSB
DNL	Differential nonlinearity	See (2)			±0.4	±1	LSB
E _{ZS}	Zero-scale error (offset error at zero scale)	See ⁽³⁾				±24	mV
E _{ZS} TC	Zero-scale-error temperature coef- ficient	See (4)			10		ppm/°C
E _G	Gain error	See ⁽⁵⁾			±0.6	% full scale V	
E _G T _C	Gain error temperature coefficient	See ⁽⁶⁾			10		ppm/°C
OUTPUT SP	ECIFICATIONS						
Vo	Output voltage	R _L = 10 kΩ		0		V _{DD} -0.4	V
	Output load regulation accuracy	$V_{\rm O} = 4.096$ V, 2.048 V, R _L = 2 ks			±0.25	% full scale V	
REFERENCE	E PIN CONFIGURED AS OUTPUT (RE	F)					
Vref(OUTL)	Low reference voltage			1.003	1.024	1.045	V
Vref(OUTH)	High reference voltage	V _{DD} > 4.75 V		2.027	2.048	2.069	V
Iref(source)	Output source current					1	mA
Iref(sink)	Output sink current			-1			mA
	Load capacitance					100	pF
PSRR	Power supply rejection ratio				-65		dB
REFERENCE	PIN CONFIGURED AS INPUT (REF)			•			
VI	Input voltage			0		V _{DD} -1.5	V
R _I	Input resistance				10		MΩ
CI	Input capacitance				5		pF
			Fast		1.3		MHz
Reference input bandwidth		REF = $0.2 V_{pp} + 1.024 V dc$	Slow	5			kHz
	Reference feedthrough	REF = 1 V _{pp} at 1.024 V dc ⁽⁷⁾	1		-80		dB
DIGITAL INP		rr		•			
I _{IH}	HIgh-level digital input current	$V_{I} = V_{DD}$				1	μA
I _{IL}	Low-level digital input current	$V_1 = 0 V$	1	-1			 μΑ
Ci	Input capacitance			1	8		pF

(1) The relative accuracy or integral nonlinearity (INL) sometimes referred to as linearity error, is the maximum deviation of the output from the line between zero and full scale excluding the effects of zero code and full-scale errors. Tested from code 32 to 4095.

(2) The differential nonlinearity (DNL) sometimes referred to as differential error, is the difference between the measured and ideal 1 LSB amplitude change of any two adjacent codes. Monotonic means the output voltage changes in the same direction (or remains constant) as a change in the digital input code.

(3)

(4)

as a change in the digital input code. Zero-scale error is the deviation from zero voltage output when the digital input code is zero. Zero-scale-error temperature coefficient is given by: $E_{ZS} TC = [E_{ZS} (T_{max}) - E_{ZS} (T_{min})]/V_{ref} \times 10^6/(T_{max} - T_{min})$. Gain error is the deviation from the ideal output ($2V_{ref} - 1 LSB$) with an output load of 10 k Ω excluding the effects of the zero-error. Gain temperature coefficient is given by: $E_G TC = [E_G(T_{max}) - E_G (T_{min})]/V_{ref} \times 10^6/(T_{max} - T_{min})$. Reference feedthrough is measured at the DAC output with an input code = 0x000. (5)

(6)

(7)



ELECTRICAL CHARACTERISTICS (CONTINUED)

over recommended operating conditions, $V_{ref} = 2.048$ V, $V_{ref} = 1.024$ V (unless otherwise noted)

ANALO	ANALOG OUTPUT DYNAMIC PERFORMANCE										
	PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT				
+	Output pottling time, full poole	$R = 10 k_0 C = 100 pE Soc(1)$	Fast		1	3					
t _{s(FS)}	Output settling time, full scale	$R_{L} = 10 \text{ k}\Omega, C_{L} = 100 \text{ pF}, \text{ See}^{(1)}$	Slow		3.5	7	μs				
+	Output settling time, code to code	$R_1 = 10 \text{ k}\Omega, C_1 = 100 \text{ pF}, \text{ See}^{(2)}$	Fast		0.5	1.5					
t _{s(CC)}	Output setting time, code to code	$R_{L} = 10 \text{ ksz}, C_{L} = 100 \text{ pr}, \text{ See } (-)$	Slow		1	2	μs				
SR	Slew rate		Fast		12						
SK	Slew fale	$R_{L} = 10 \text{ k}\Omega, C_{L} = 100 \text{ pF}, \text{ See}^{(3)}$	Slow		1.8		V/µs				
	Glitch energy	DIN = 0 to 1, FCLK = 100 kHz, $\overline{CS} = V_{DD}$			5		nV-s				
SNR	Signal-to-noise ratio			69	74						
S/(N+D)	Signal-to-noise + distortion	$f_{s} = 480$ kSPS, $f_{out} = 1$ kHz, $R_{L} = 10$ kΩ,		58	67		dB				
THD	Total harmonic distortion	$\breve{C}_{L} = 100 \text{pF}$			69	57	uв				
Spurious free dynamic range				57	72						

Settling time is the time for the output signal to remain within ±0.5 LSB of the final measured value for a digital input code change of (1)

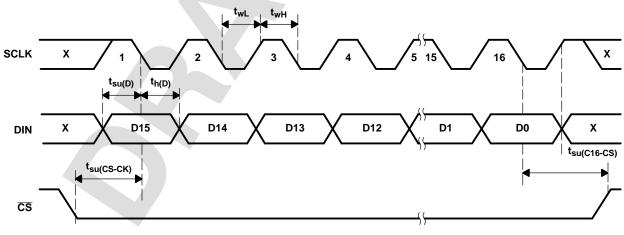
0x020 to 0xFDF and 0xFDF to 0x020 respectively. Not tested, assured by design. Settling time is the time for the output signal to remain within \pm 0.5 LSB of the final measured value for a digital input code change of (2)one count. Not tested, assured by design.

Slew rate determines the time it takes for a change of the DAC output from 10% to 90% full-scale voltage. (3)

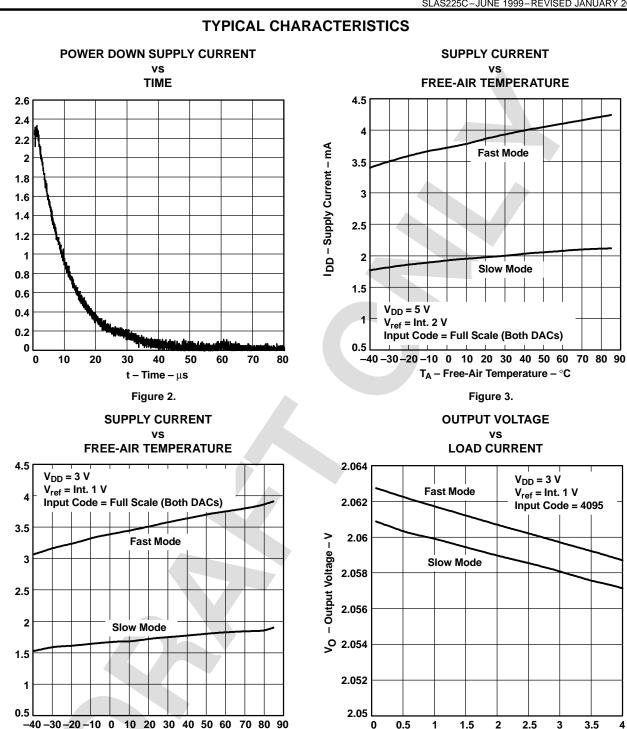
DIGITAL INPUT TIMING REQUIREMENTS

		MIN	NOM	MAX	UNIT
t _{su(CS-CK)}	Setup time, CS low before first negative SCLK edge	10			ns
t _{su(C16-CS)}	Setup time, 16^{th} negative SCLK edge (when D0 is sampled) before \overline{CS} rising edge	10			ns
t _{wH}	SCLK pulse width high	25			ns
t _{wL}	SCLK pulse width low	25			ns
t _{su(D)}	Setup time, data ready before SCLK falling edge	10			ns
t _{h(D)}	Hold time, data held valid after SCLK falling edge	5			ns

PARAMETER MEASURMENT INFORMATION







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DD – Power Down Supply Current – mA

IDD – Supply Current – mA

T_A – Free-Air Temperature – °C

Figure 4.

Source Current - mA

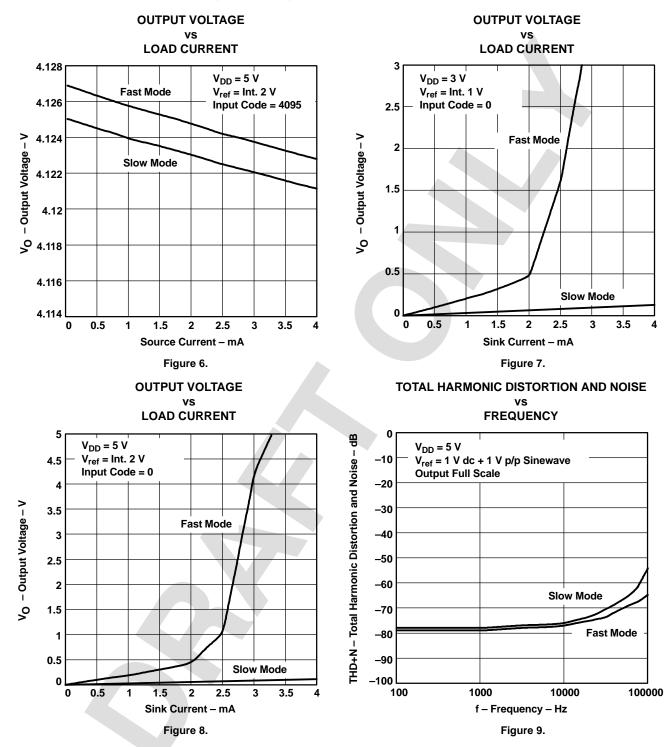
Figure 5.

7

4

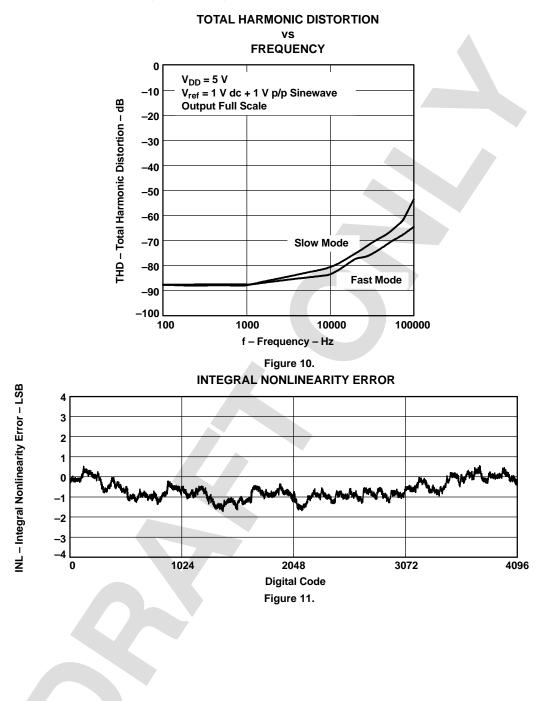


TYPICAL CHARACTERISTICS (continued)



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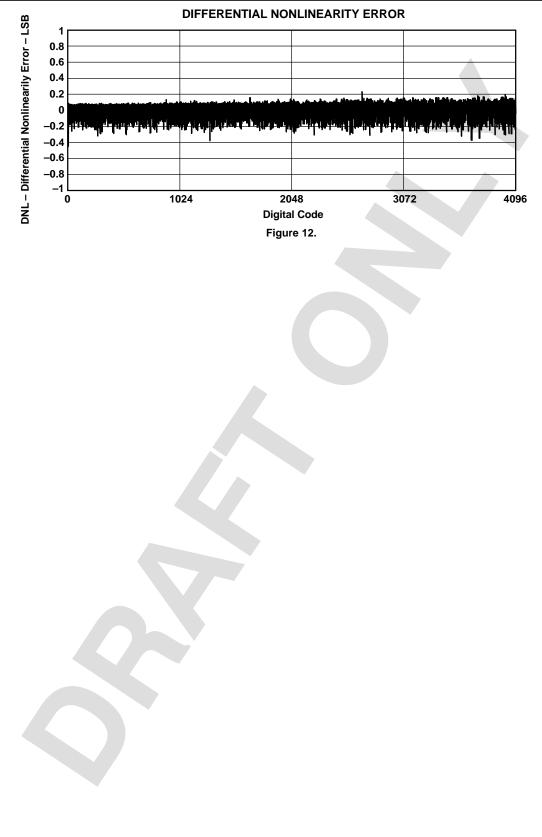




TLV5638



SLAS225C-JUNE 1999-REVISED JANUARY 2004





APPLICATION INFORMATION

GENERAL FUNCTION

The TLV5638 is a dual 12-bit, single supply DAC, based on a resistor string architecture. It consists of a serial interface, a speed and power-down control logic, a programmable internal reference, a resistor string, and a rail-to-rail output buffer.

The output voltage (full scale determined by reference) is given by:

$$2 \text{ REF } \frac{\text{CODE}}{0x1000} \text{ [V]}$$

Where REF is the reference voltage and CODE is the digital input value in the range 0x000 to 0xFFF. A power on reset initially puts the internal latches to a defined state (all bits zero).

SERIAL INTERFACE

A falling edge of \overline{CS} starts shifting the data bit-per-bit (starting with the MSB) to the internal register on the falling edges of SCLK. After 16 bits have been transferred or \overline{CS} rises, the content of the shift register is moved to the target latches (DAC A, DAC B, BUFFER, CONTROL), depending on the control bits within the data word.

Figure 13 shows examples of how to connect the TLV5638 to TMS320, SPI™, and Microwire™.

TMS320	1	TLV5638	SPI	TLV5638	Microwire	TLV5638
DSP FS)	(<u> </u>	CS	I/O	 CS	I/O	CS
D	(<u> </u>	DIN	MOSI	 DIN	SO	DIN
CLK)	<	SCLK	SCK	SCLK	SK	SCLK

Figure 13. Three-Wire Interface

Notes on SPI[™] and Microwire[™]: Before the controller starts the data transfer, the software has to generate a falling edge on the pin connected to FS. If the word width is 8 bits (SPI[™] and Microwire[™]), two write operations must be performed to program the TLV5638. After the write operation(s), the holding registers or the control register are updated automatically on the 16th positive clock edge.

SERIAL CLOCK FREQUENCY AND UPDATE RATE

The maximum serial clock frequency is given by:

$$f_{sclkmax} = \frac{1}{t_{whmin} + t_{wlmin}} = 20 \text{ MHz}$$

The maximum update rate is:

$$f_{updatemax} = \frac{1}{16 (t_{whmin} + t_{wlmin})} = 1.25 \text{ MHz}$$

Note, that the maximum update rate is just a theoretical value for the serial interface, as the settling time of the TLV5638 has to be considered, too.

APPLICATION INFORMATION (continued)

DATA FORMAT

The 16-bit data word for the TLV5638 consists of two parts:

- Program bits (D15..D12)
- New data (D11..D0)

	(- /													
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
R1	SPD	PWR	R0	12 Data bits											
SPD: Speed control bit $1 \rightarrow$ fast mode								$0 \rightarrow$	slow r	node					
PWR: Pow	er contro	Ibit 1	\rightarrow powe	er down	er down $0 \rightarrow \text{normal operation}$										

The following table lists the possible combination of the register select bits:

REGISTERED SELECT BITS

R1	R0	REGISTER
0	0	Write data to DAC B and BUFFER
0	1	Write data to BUFFER
1	0	Write data to DAC A and update DAC B with BUFFER content
1	1	Write data to control register

The meaning of the 12 data bits depends on the register. If one of the DAC registers or the BUFFER is selected, then the 12 data bits determine the new DAC value:

DATA BITS: DAC A, DAC B and BUFFER

D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
					New DA	C Value					

If control is selected, then D1, D0 of the 12 data bits are used to program the reference voltage:

DATA BITS: CONTROL

D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
Х	X	Х	Х	X	X	Х	Х	Х	Х	REF1	REF0

REF1 and REF0 determine the reference source and, if internal reference is selected, the reference voltage.

REFERENCE BITS

REF1	REF0	REFERENCE
0	0	External
0	1	1.024 V
1	0	2.048 V
1	1	External

CAUTION:

If external reference voltage is applied to the REF pin, external reference MUST be selected.



EXAMPLES OF OPERATION:

- 1. Set DAC A output, select fast mode, select internal reference at 2.048 V:
 - a. Set reference voltage to 2.048 V (CONTROL register)

			. 0		`		0	,							
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
1	1	0	1	0	0	0	0	0	0	0	0	0	0	1	0

b. Write new DAC A value and update DAC A output:

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
1	1	0	0	New DAC A output value											

The DAC A output is updated on the rising clock edge after D0 is sampled.

To output data consecutively using the same DAC configuration, it is not necessary to program the CONTROL register again.

2. Set DAC B output, select fast mode, select external reference:

a. Select external reference (CONTROL register):

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0

b. Write new DAC B value to BUFFER and update DAC B output:

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
0	1	0	0	New BUFFER content and DAC B output value											

The DAC A output is updated on the rising clock edge after D0 is sampled.

To output data consecutively using the same DAC configuration, it is not necessary to program the CONTROL register again.

- 3. Set DAC A value, set DAC B value, update both simultaneously, select slow mode, select internal reference at 1.024 V:
 - a. Set reference voltage to 1.024 V (CONTROL register)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
1	0	0	1	0	0	0	0	0	0	0	0	0	0	0	1

b. Write data for DAC B to BUFFER:

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	1						New D	AC B valu	е				

c. Write new DAC A value and update DAC A and B simultaneously:

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
1	0	0	0		New DAC A value										

Both outputs are updated on the rising clock edge after D0 from the DAC A data word is sampled.

To output data consecutively using the same DAC configuration, it is not necessary to program the CONTROL register again.

1. Set power-down mode:

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
X	X	1	Х	Х	Х	Х	Х	Х	Х	Х	Х	X	Х	Х	Х

#IMPLIED. X = Don't care

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LINEARITY, OFFSET, AND GAIN ERROR USING SINGLE ENDED SUPPLIES

When an amplifier is operated from a single supply, the voltage offset can still be either positive or negative. With a positive offset, the output voltage changes on the first code change. With a negative offset, the output voltage may not change with the first code, depending on the magnitude of the offset voltage.

The output amplifier attempts to drive the output to a negative voltage. However, because the most negative supply rail is ground, the output cannot drive below ground and clamps the output at 0 V.

The output voltage then remains at zero until the input code value produces a sufficient positive output voltage to overcome the negative offset voltage, resulting in the transfer function shown in Figure 14.

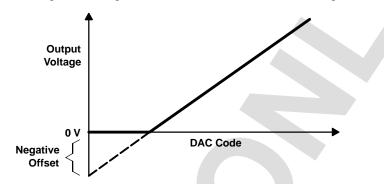


Figure 14. Effect of Negative Offset (Single Supply)

This offset error, not the linearity error, produces this breakpoint. The transfer function would have followed the dotted line if the output buffer could drive below the ground rail.

For a DAC, linearity is measured between zero-input code (all inputs 0) and full-scale code (all inputs 1) after offset and full scale are adjusted out or accounted for in some way. However, single supply operation does not allow for adjustment when the offset is negative due to the breakpoint in the transfer function. So the linearity is measured between full-scale code and the lowest code that produces a positive output voltage.



DEFINITIONS OF SPECIFICATIONS AND TERMINOLOGY

Integral Nonlinearity (INL)

The relative accuracy or integral nonlinearity (INL), sometimes referred to as linearity error, is the maximum deviation of the output from the line between zero and full scale excluding the effects of zero code and full-scale errors.

Differential Nonlinearity (DNL)

The differential nonlinearity (DNL), sometimes referred to as differential error, is the difference between the measured and ideal 1 LSB amplitude change of any two adjacent codes. Monotonic means the output voltage changes in the same direction (or remains constant) as a change in the digital input code.

Zero-Scale Error (E_{ZS})

Zero-scale error is defined as the deviation of the output from 0 V at a digital input value of 0.

Gain Error (E_G)

Gain error is the error in slope of the DAC transfer function.

Total Harmonic Distortion (THD)

THD is the ratio of the rms value of the first six harmonic components to the value of the fundamental signal. The value for THD is expressed in decibels.

Signal-to-Noise Ratio + Distortion (S/N+D)

S/N+D is the ratio of the rms value of the output signal to the rms sum of all other spectral components below the Nyquist frequency, including harmonics but excluding dc. The value for S/N+D is expressed in decibels.

Spurious Free Dynamic Range (SFDR)

Spurious free dynamic range is the difference between the rms value of the output signal and the rms value of the largest spurious signal within a specified bandwidth. The value for SFDR is expressed in decibels.

MECHANICAL DATA

MCER001A - JANUARY 1995 - REVISED JANUARY 1997



CERAMIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification.
- E. Falls within MIL STD 1835 GDIP1-T8



MLCC006B - OCTOBER 1996

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004

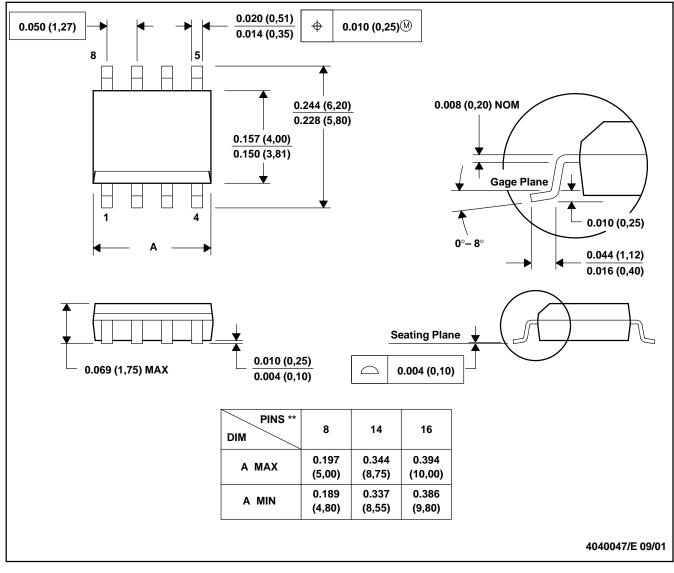


MECHANICAL DATA

MSOI002B - JANUARY 1995 - REVISED SEPTEMBER 2001

PLASTIC SMALL-OUTLINE PACKAGE

D (R-PDSO-G**) 8 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012



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